

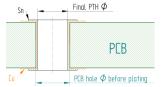
Specifications for Printed Circuit Boards

- 1. Printed board thickness must not be less than 1.6 mm
- 2. PCB material should comply with IEC 61249-2-7
- 3. Both sides of the PCB should be covered with solder mask
 - 4. Minimum distance between the edge of the PCB and the centre of the pin hole: 4 mm
 - 5. Minimum distance between the centre of the pin hole
- and the component on the PCB: 4 mm

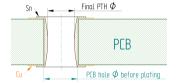
 6. Plated through-hole specifications for Press-fit pin:
 - Hole diameter before plating: 1.6 mm ± 0.025 mm
 - o Thickness of the PTH wall > 25 μm Cu
 - o Plated hole final diameter: 1.45 mm +0.09 mm / -0.06 mm
 - Minimum Cu width of the annular ring > 0.1 mm Through hole position accuracy ±0.1 mm

 - o for chemical tin plating (Sn): 0.5 μm to 10 μm

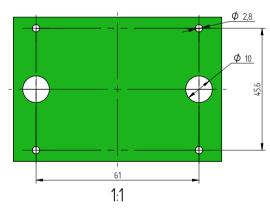
The PCB can be disassembled and reused 2 more times.



- 1. Figure: Chemical tin plating (for illustration only, no real proportions)
- $_{\odot}~$ for HAL tin plating (Sn): 0.5 μm to 50 μm The PCB can be disassembled and reused 2 more times.



- 2. Figure: HAL tin plating (for illustration only, no real proportions)
- Au: not generally released; individual release of PCB system required
- 7. For any other requirements IEC 60352-5 standard should be considered
- 8. Recommended hole and cutout dimensions on the PCB:



General notes:

- Tolerance of pin positions ±0.5 mm at the end of pins
- Refer to the module datasheet for pinout and 3D-CAD model
- Mounting parameters see in the actual Handling Instructions

ſ											View
										Package Drawing	scale
I	01	2017.06	.13						Gyimóthy Zs.	I ackage Diawing	2:1
	Rev.	Rev. Date Alteration						Designed	Approved		
General tolerances ISO 2768 - m , K Ps A3							Ps A3				Page
I	Linear din	nensions	x<0,5±0,05	0,5≤x<6±0,1	6≤x<30 ±0,2	30≤x<120±0,3	120 < x ±0,5	Vincotech		Flow1C-4T12WTF-*-PD	I 1/1 I
I	Chamfers, radii		x<0,3 ±0,05	0,3≤x<0,5±0,1	0,5≤x<3±0,2	3≤x<6±0,5	6 <x±1< td=""><td colspan="2">•</td><td></td><td>17 1</td></x±1<>	•			17 1
I	Referer	ices	Inspectional dim:		Revision number (Rev.):		: *	IP Development		Drawing alteration in revision: {}	₩